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Amdt.  
SDavis  
5/20/03Serial No. 09/879,724  
Amendment Dated May 19, 2003Attorney Docket No. F0522  
Response To Office Action Dated April 4, 2003**CERTIFICATE OF MAILING OR FACSIMILE TRANSMISSION UNDER 37 CFR 1.8(a)**

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is  
being deposited with the United States Postal Service with sufficient postage for first class mail in an envelope addressed to  
the Commissioner for Patents address below.  
X being transmitted via facsimile to (703) 872-9318 at the U.S. Patent and Trademark Office to the Attention of Examiner  
Ahmed N. Sefer.

Andrew Romero  
Andrew RomeroMay 19, 2003  
Date**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re patent application of:

Applicant: Dong-Hyuk Ju et al.

Serial No: 09/879,724<sup>d</sup>Filing Date: June 12, 2001<sup>d</sup>

Art Unit: 2826

Examiner: Ahmed N. Sefer

Confirmation No: 4898

**Title: LEAKY, THERMALLY CONDUCTIVE INSULATOR MATERIAL (LTCIM)  
IN SEMICONDUCTOR-ON-INSULATOR (SOI) STRUCTURE**Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450**REPLY TO OFFICE ACTION DATED APRIL 4, 2003**

Dear Sir

Favorable reconsideration of the above-identified application is respectfully requested in view of the following amendments and comments. Additionally, please find enclosed a Supplemental Information Disclosure Statement (IDS). A copy of the cited reference is not enclosed per Examiner Sefer's authorization in a teleconference on May 19, 2003. The Commissioner is authorized to charge any fees to Deposit Account No. 18-0988, i.e., \$180.00, in satisfaction of the IDS.

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Amendments in the Claims are reflected in the listing of claims that begins on page 3 of this paper.

Remarks begin on page 6 of this paper.